	Material Comp © Copyright 2005. I international and Par	osition Dee PC, Bannockt	claration ourn, Illinois. A opyright conver	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarat he declaration e	ion of the sencompasse	substances es all lowe	within the r level mate	manufacture erials for wh	er listed it hich the m	em. Note: if anufacturer	the item is an as has engineering	ssembly with lowe responsibility.	
1752-21.1	1 IPC Web Site for Information on IPC-1752 Standard Form 7				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					eous Materia	als and Mfg Information				
Supplier	r Information															
Company name* Company				unique ID			Unique ID Authority					Response Date*				
onsemi												2024-05-04				
Contact N	lame		Title - Contact				Phone - Contact*					Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Iter		n Number Mfr Item Name				Effective Date	Version	1 N	Manufacturing Site		V	Veight*	UOM	Unit Type	
	MPSA29			BIPOLAR TRANSISTOR TO-92			2024-05-04 CNF			223.092		mg	Each			
/Ianufa	cturing Proccess Informa	tion		·												
	Terminal Plating / Grid Array Material			Terminal Base Alloy J-STD-020 M		L Rating	Peak Process Body Temperatu		ure Max Time at Peak Tempera		Temperate	ure Numb	er of Reflow Cyc	cles		
Matte Tin (Sn) - annealed C			CU Alloy NA				0 C 30				seconds 3					
omments	3															
or more i	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration				Declaration Type *	Detailed
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		nium (Cr6+), Polybro	ominated Biphenyls (PBB), Polybron	dmium and quantity limit of 0.1% by mass (100 minated Diphenyl Ethers (PBDE), and Bis(2-eth	
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all
Exemption List Version	EL-2011/534/EU				
Declaration Signature					
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the
Supplier Digital Signature Ra	stislav Drska	Le			

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

sigma range of distribution unless	otherwise noted).							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.075	mg	Supplier	Silicon (Si)	7440-21-3		0.075	mg
Lead Frame	101.001	mg	Supplier	Silver (Ag)	7440-22-4		1.01	mg
			Supplier	Manganese (Mn)	7439-96-5		0.505	mg
			В	Nickel (Ni)	7440-02-0		0.182	mg
			Supplier	Iron (Fe)	7439-89-6		98.4	mg
			Supplier	Copper (Cu)	7440-50-8		0.904	mg
Mold Compound-Black	112.0	mg	Supplier	2,6-dibromo-4-[1-(3-bromo-4- hydroxyphenyl)-1-methylethyl]phenol	6386-73-8		3.36	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		22.4	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		2.8	mg
			Supplier	Carbon Black (C)	1333-86-4		0.84	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		82.6	mg
Plating	9.94	mg	Supplier	Tin (Sn)	7440-31-5		9.94	mg
Wire Bond - Au	0.076	mg	Supplier	Gold (Au)	7440-57-5		0.076	mg

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 signa range of distribution unless otherwise noted).